

LNJ757W86RA

High Bright Surface Mounting Chip LED

ESS Type

■ Absolute Maximum Ratings $T_a = 25^{\circ}\text{C}$

- Pure Green

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	75	mW
Forward current	I_F	20	mA
Pulse forward current *	I_{FP}	70	mA
Reverse voltage	V_R	5	V
Operating ambient temperature	T_{opr}	-30 to +85	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^{\circ}\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Lighting Color

- Pure Green
- Blue
- Red

- Blue

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	75	mW
Forward current	I_F	20	mA
Pulse forward current *	I_{FP}	70	mA
Reverse voltage	V_R	5	V
Operating ambient temperature	T_{opr}	-30 to +85	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^{\circ}\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

- Red

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	55	mW
Forward current	I_F	20	mA
Pulse forward current *	I_{FP}	60	mA
Reverse voltage	V_R	4	V
Operating ambient temperature	T_{opr}	-30 to +85	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^{\circ}\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

• Pure Green

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 5 \text{ mA}$	20	90	180	mcd
Forward current	I_R	$V_R = 5 \text{ V}$			100	μA
Forward voltage	V_F	$I_F = 5 \text{ mA}$		3.0	3.3	V
Peak emission wavelength	λ_P	$I_F = 5 \text{ mA}$		520		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	518	525	533	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		40		nm

Note) *1: Measurement tolerance: $\pm 20\%$

*2: Measurement tolerance: $\pm 3 \text{ nm}$

• Blue

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 5 \text{ mA}$	7	15	25	mcd
Reverse current	I_R	$V_R = 5 \text{ V}$			100	μA
Forward voltage	V_F	$I_F = 5 \text{ mA}$		2.95	3.30	V
Peak emission wavelength	λ_P	$I_F = 5 \text{ mA}$		462		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	465	470	474	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		30		nm

Note) *1: Measurement tolerance: $\pm 20\%$

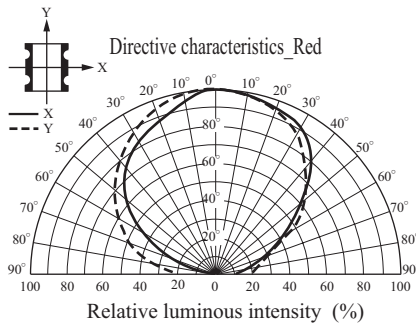
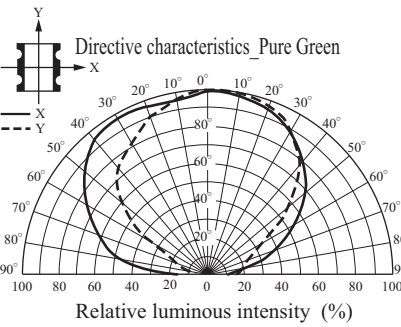
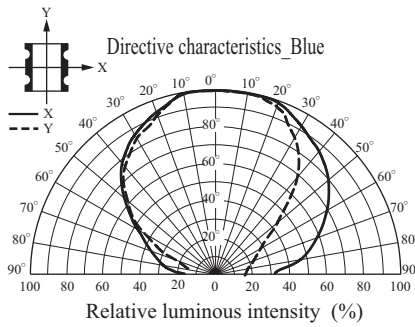
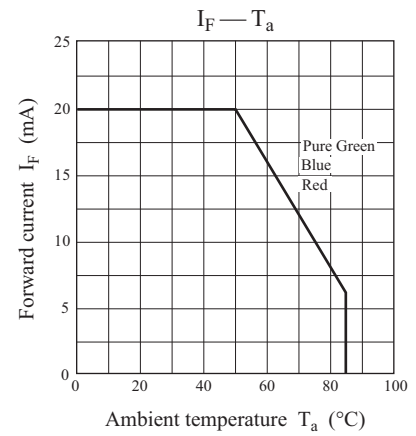
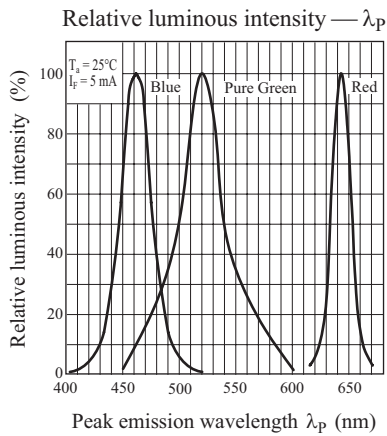
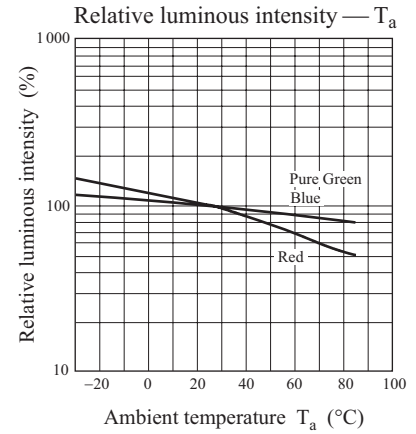
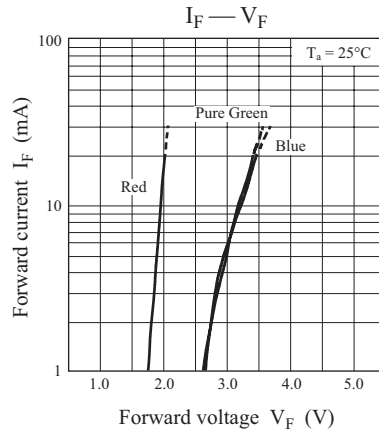
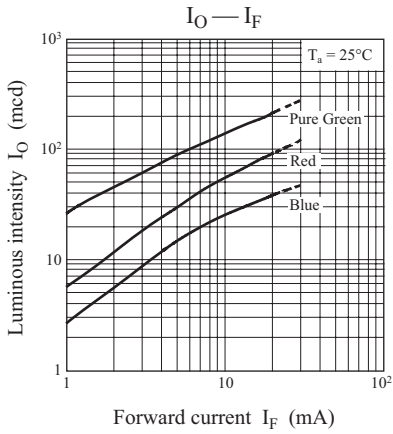
*2: Measurement tolerance: $\pm 3 \text{ nm}$

• Red

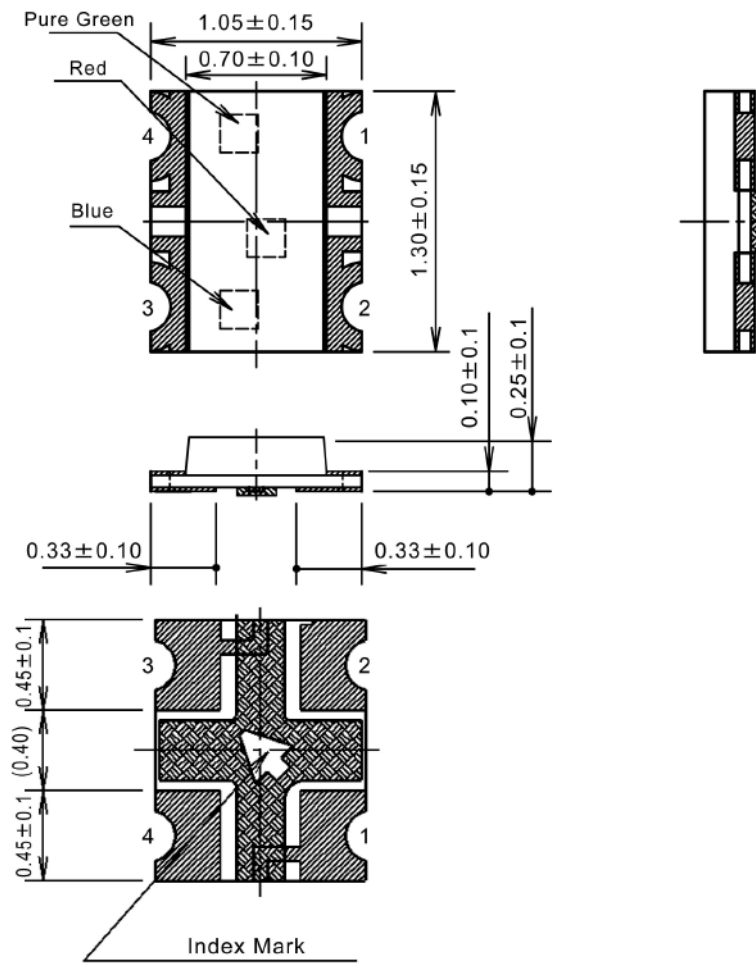
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 5 \text{ mA}$	15	30	45	mcd
Reverse current	I_R	$V_R = 4 \text{ V}$			100	μA
Forward voltage	V_F	$I_F = 5 \text{ mA}$		1.9	2.3	V
Peak emission wavelength	λ_P	$I_F = 5 \text{ mA}$		643		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	621	628	634	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		20		nm

Note) *1: Measurement tolerance: $\pm 20\%$

*2: Measurement tolerance: $\pm 3 \text{ nm}$



■ Package (Unit: mm)



• Pin name

- 1: Anode
- 2: Cathode (Red)
- 3: Cathode (Blue)
- 4: Cathode (Pure Green)

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